

September 2015

# FDC5661N\_F085

# N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET 60V, 4A, $60 \text{m}\Omega$

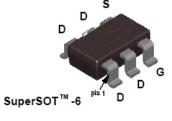
#### **Features**

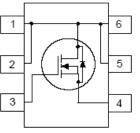
- $\blacksquare$  R<sub>DS(on)</sub> = 47m $\Omega$  at V<sub>GS</sub> = 10V, I<sub>D</sub> = 4.3A
- $\blacksquare$  R<sub>DS(on)</sub> = 60m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 4A
- Typ  $Q_{g(TOT)}$  = 14.5nC at  $V_{GS}$  = 10V
- Low Miller Charge
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

# **Applications**

- DC/DC converter
- Motor Drives







# MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
$V_{DSS}$	Drain to Source Voltage		60	V
$V_{GS}$	Gate to Source Voltage	±20	V	
Drain Current Continuous (V <sub>GS</sub> = 10V)		4.3	^	
I <sub>D</sub>	Pulsed		20	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 1	1)	81	mJ
$P_D$	Power Dissipation		1.6	W
$T_J, T_{STG}$	Operating and Storage Temperature		-55 to +150	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case		30	oC/M
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-263, 1in <sup>2</sup> copper pad area	а	78	°C/W

#### Notes:

1:  $E_{AS}$  of 81 mJ is 100% test at L = 14mH,  $I_{AS}$  = 3.4A, starting  $T_J$  = 25°C

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.661N	FDC5661N	SSOT-6	7"	8mm	3000 units

Units

Max

# **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

**Parameter** 

Off Characteristics							
$B_{VDSS}$	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} =$	0V	60	-	-	V
1	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 48V,		-	-	1	μА
I <sub>DSS</sub> Zero Gate voltage Drain Current	Zelo Gale Vollage Dialii Cullelli	$V_{GS} = 0V$	$T_A = 150^{\circ}C$	-	-	250	μΑ
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

**Test Conditions** 

Min

Тур

### **On Characteristics**

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	2.0	3	V
Proin to Source On Recistance	$I_D = 4.3A, V_{GS} = 10V$	-	38	47		
	r <sub>DS(on)</sub> Drain to Source On Resistance	$I_D = 4A, V_{GS} = 4.5V$	-	46	60	mΩ
DS(on)		$I_D = 4.3A, V_{GS} = 10V$ $T_J = 150^{\circ}C$	-	69	86	11122

## **Dynamic Characteristics**

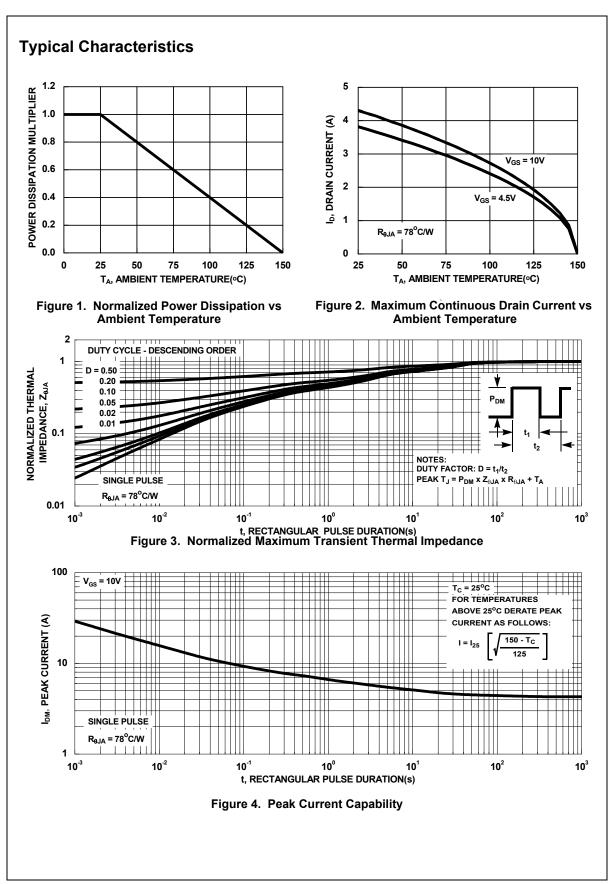
C <sub>iss</sub>	Input Capacitance	V 05V V 0V		-	763	-	pF
Coss	Output Capacitance		$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz		68	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 111112			36	-	pF
$R_G$	Gate Resistance	f = 1MHz		-	2.6	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	V <sub>GS</sub> = 0 to 10V		14.5	19	nC
$Q_{gs}$	Gate to Source Gate Charge		$V_{DD} = 30V$ $I_{D} = 4.3A$	-	2.4	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		- ID - 4.0A		2.9	-	nC

# **Switching Characteristics**

t <sub>on</sub>	Turn-On Time		-	-	17.6	ns
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 30V, I_{D} = 4.3A$ $V_{GS} = 10V, R_{GS} = 6\Omega$	1	7.2	1	ns
t <sub>r</sub>	Rise Time		1	1.6	1	ns
$t_{d(off)}$	Turn-Off Delay Time	VGS = 10V, NGS = 052	-	19.3	-	ns
t <sub>f</sub>	Fall Time		-	3.1	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	36	ns

#### **Drain-Source Diode Characteristics**

V <sub>SD</sub> Source to Drain Diode Voltage	Source to Drain Diade Voltage	I <sub>SD</sub> = 4.3A	-	8.0	1.25	V
	I <sub>SD</sub> = 2.1A	-	0.8	1.0	V	
t <sub>rr</sub>	Reverse Recovery Time	L = 4.24 dL /dt = 1004/		18.4	24	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{SD} = 4.3A$ , $dI_{SD}/dt = 100A/\mu s$	-	10.0	13	nC



# **Typical Characteristics**

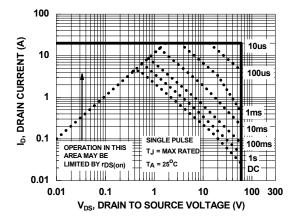


Figure 5. Forward Bias Safe Operating Area

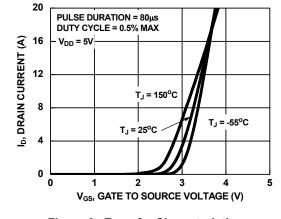


Figure 6. Transfer Characteristics

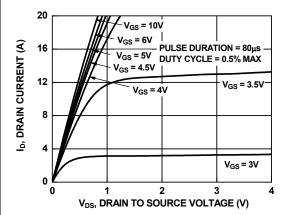


Figure 7. Saturation Characteristics

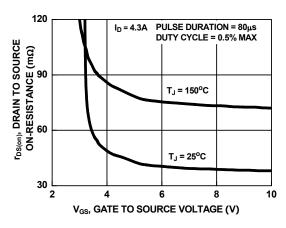


Figure 8. Drain to Source On-Resistance Variation vs Gate to Source Voltage

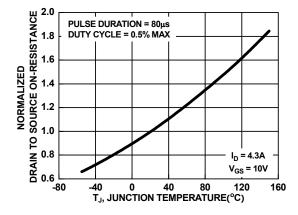


Figure 9. Normalized Drain to Source On Resistance vs Junction Temperature

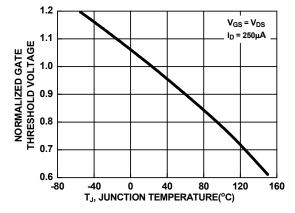


Figure 10. Normalized Gate Threshold Voltage vs Junction Temperature

# **Typical Characteristics**

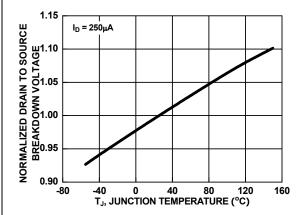


Figure 11. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

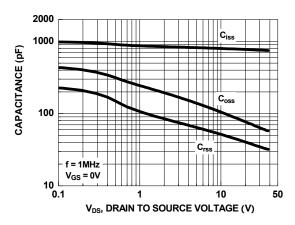


Figure 12. Capacitance vs Drain to Source Voltage
Figure 14.

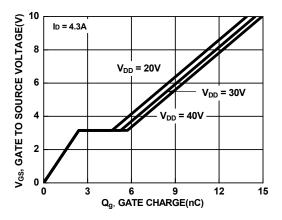
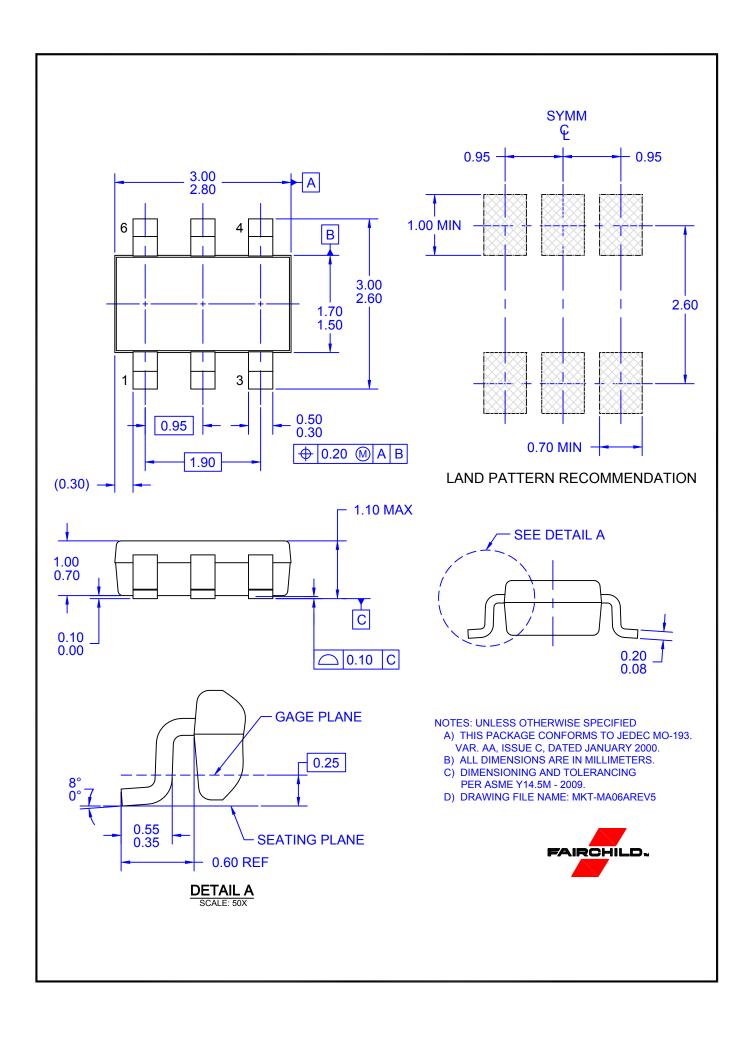


Figure 13. Gate Charge vs Gate to Source Voltage







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